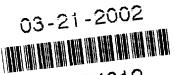
FORM PTO-1595

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RECORDATION



TMENT OF COMMERCE

102024912 PATEN ratent and Trademark Office 1/31/92 To the Honorable Commissioner of Patents and Trademarks: Please Record the attached original documents or copy thereof. 1. Name of conveying party(ies): 3.8.02 2. Name and address of receiving party(ies): Name: Sony Corporation SHUNJI AMANO MOTOSUKE OHMI Internal Address: 7-35, Kitashinagawa 6-chome JUNICHI OHSAKO Shinagawa-ku, Tokyo 141, Japan RYOTA ODAKE HIROSHI OZAKI Additional name(s) of conveying party(ies) Street Address: attached? ☐ Yes ⋈ No __State:___Zip: City: 3. Nature of conveyance: □ Merger Additional Name(s) & Address(es) attached ☐ Yes ⊠ No □ Security Agreement □ Change of Name □ Other Execution Date February 4, 5 and 12, 2002 4. Application (number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application is: B: Patent No.(s) Patent Application No.(s) U.S. Serial No. 10/005,960 filed December 3, 2001 Attorney Docket No. 09792909-5275 6. Total number of applications and patents involved 5. Name and address of party to whom correspondence concerning document should be mailed: Authorized to be charged to deposit account any SONNENSCHEIN NATH & ROSENTHAL Additional fees P.O. Box #061080 8. Deposit Account Number: Wacker Drive Station 19.3140 **Sears Tower** (Attach duplicate copy of this page if paying by deposit account) Chicago, IL 60606-1080 Customer ID No. 26263 DO NOT USE THIS SPACE 9 Statement and signature: To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document, February 28, 2002 David R. Metzger Date Name of Person Signing Total number of pages 4 Mail documents to be recorded and required cover sheet information to: Commissioner of Patents and Trademarks **Box Assignments** Washington, D.C. 20231+ 00000132 10005960 03/20/2002 DBYNNE 40.00 OP

Docket Number: 09792909-5275

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in DISPLAY DEVICE, PRODUCING METHOD OF ELECTRONIC APPARATUS AND DISPLAY DEVICE

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said applicat on disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt ard sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Fatents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to sa d application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 10/005,960 Filing Date: Dec. 3, 2001

This assignment executed on the dates indicated below.

| SHUN KAYAMA | |
|-------------------------------------|-------------------------------------------|
| Name of first or sole inventor | Execution date of U.S. Patent Application |
| SAITAMA, JAPAN | |
| Residence of first or sole inventor | February 4, 2002 |
| 5'HUN KATAMA | |
| Signature of first or sole inventor | Date of this assignment |

| SHUNJI AMANO | |
|------------------------------------------------------------|------------------------------------------------|
| Name of second inventor | Execution date of U.S. Patent Application |
| SAITAMA, JAPAN | |
| Residence of second inventor Signature of second inventor | February 5, 2002 5 A, Date of this assignment |
| Signature of second inventor | Date of this assignment |
| MOTOSUKE OHMI | |
| Name of third inventor | Execution date of U.S. Patent Application |
| TOKYO, JAPAN | |
| Residence of third inventor | February 5, 2002 |
| Signature of third inventor | February 5, 2002 Date of this assignment |
| JUNICHI OHSAKO | Execution date of U.S. Patent Application |
| Name of fourth inventor | |
| TOKYO, JAPAN Residence of fourth inventor | |
| Residence of fourth inventor | Fabruary 5, 2002 Date of this assignment |
| Residence of fourth inventor Signature of fourth inventor | Date of this assignment |
| FYOTA ODAKE Name of 16th inventor | Execution date of U.S. Patent Application |
| JOKYO, JAPAN | |
| Residence of fifth inventor | Date of this assignment |
| Signature of fifth inventor | Date of this assignment |

| H]ROSHI OZAKI | |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------|
| Name of sixth inventor | Execution date of U.S. Patent Application |
| SFITAMA, JAPAN | |
| Residence of sixth inventor | |
| Signature of sixth inventor | February 12, 2002 Date of this assignment |
| Signature o sixth inventor | Date of this assignment |
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| Name of seventh inventor | Execution data -CHC Data A 11 11 |
| Name of Seventh inventor | Execution date of U.S. Patent Application |
| Residence of seventh inventor | |
| The state of the s | |
| Signature o'seventh inventor | Date of this assignment |
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| | CIIC Day to Application |
| Name of eighth inventor | Execution date of U.S. Patent Application |
| | |
| Residence of eighth inventor | |
| 2 Lab inventor | Date of this assignment |
| Signature o'eighth inventor | |
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| Name of ninth inventor | Execution date of U.S. Patent Application |
| | |
| Residence of ninth inventor | |
| | Date of this assignment |
| Signature of ninth inventor | Date of this assignment |

RECORDED: 03/08/2002 REEL: 012688